



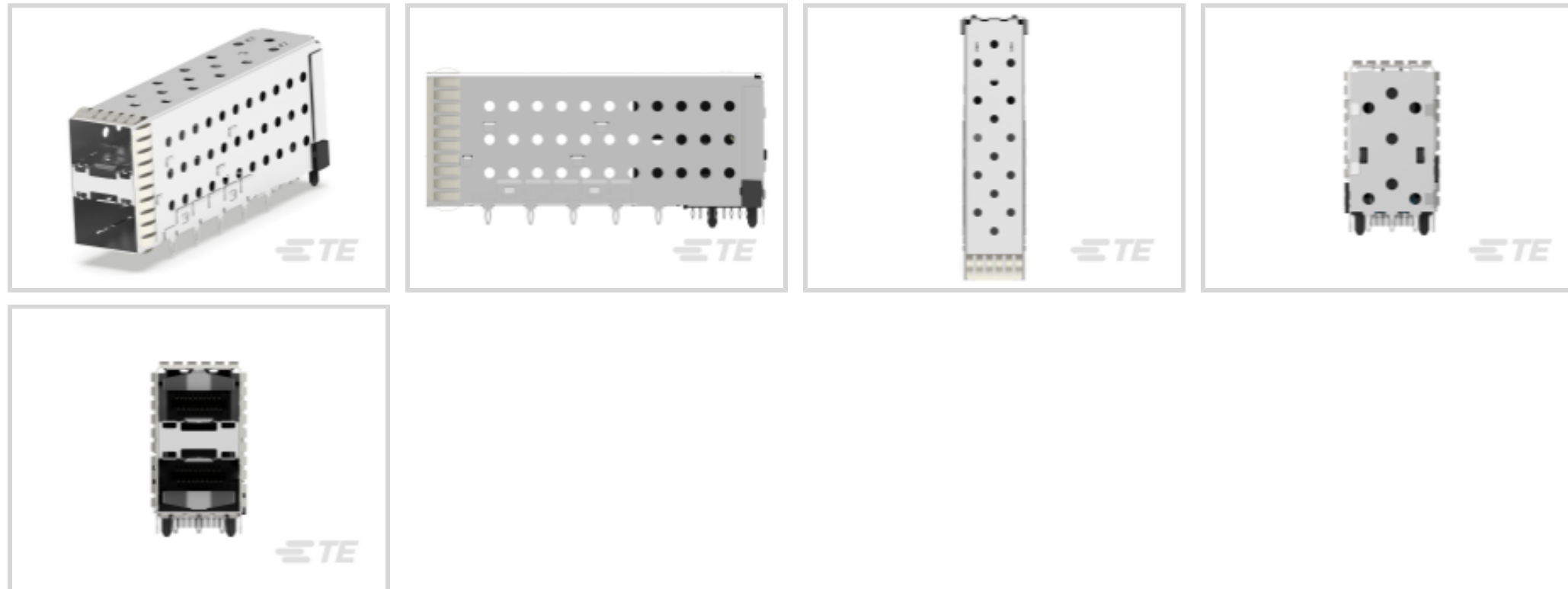
SFP28

TE Internal #: 1-2007492-8

SFP, SFP+ & zSFP+, Cage Assembly with Integrated Connector, Data Rate (Max) 16 Gb/s, External Springs, EMI Enhanced, With Lightpipe, 2 x 1

[View on TE.com >](#)

Connectors > Pluggable IO Connectors & Cages > SFP, SFP+ & zSFP+ > SFP+ Stacked Cage Assemblies



Pluggable I/O Product Type: **Cage Assembly with Integrated Connector**

Data Rate (Max): **16 Gb/s**

EMI Containment Feature Type: **External Springs**

Pluggable I/O Applications: **EMI Enhanced**

Lightpipe Options: **With Lightpipe**

[All SFP+ Stacked Cage Assemblies \(125\)](#)

Features

Product Type Features

Form Factor	SFP+
Cage Type	Stacked
Pluggable I/O Product Type	Cage Assembly with Integrated Connector
Lightpipe Options	With Lightpipe
Connector System	Cable-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Port Matrix Configuration	2 x 1
Number of Ports	2
Number of Positions	40

Electrical Characteristics

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Data Rate (Max)	16 Gb/s
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Contact Features

Tail Plating Material	Tin
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Contact Mating Area Plating Material Thickness	.76 μ m
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Contact Mating Area Plating Material	Gold or Gold Flash over Palladium Nickel
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Termination Features

Termination Post & Tail Length	3 mm [.118 in]
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Termination Method to Printed Circuit Board	Through Hole - Press-Fit
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Mechanical Attachment

Connector Mounting Type	Board Mount
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Housing Features

Cage Material	Nickel Silver
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Centerline (Pitch)	.8 mm [.032 in]
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Dimensions

PCB Thickness (Recommended)	1.5 mm [.059 in]
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Usage Conditions

Operating Temperature Range	-55 – 105 °C [-67 – 221 °F]
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Operation/Application

Heat Sink Compatible	No
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Pluggable I/O Applications	EMI Enhanced
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Circuit Application	Signal
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Industry Standards

UL Flammability Rating	UL 94V-0
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Packaging Features

Packaging Method	Package
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Other

EMI Containment Feature Type	External Springs
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Product Compliance

For compliance documentation, visit the product page on [TE.com](https://www.te.com)>

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JUNE 2022 (224) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not applicable for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts

 <p>TE Part # CAT-C11-H50626 SFP+ to SFP+ I/O Cable Assembly: 30 AWG</p>	 <p>TE Part # CAT-C11-N490333 QSFP28-Four SFP+ Cable Assembly: 30 AWG</p>	 <p>TE Part # CAT-C11-N490325 QSFP28-Four SFP+ Cable Assembly: 26 AWG</p>	 <p>TE Part # 2334985-2 SFP28 DIRECT ATTACH CA, 1M, 32AWG</p>
 <p>TE Part # CAT-C11-N4901114 SFP28 to SFP28 Cable Assembly: 30 AWG</p>	 <p>TE Part # CAT-C11-N49011 SFP28 to SFP28 Cable Assembly: 26 AWG</p>	 <p>TE Part # CAT-Q17-N49011 QSFP56-Four SFP56 Cable Assembly: 30 AWG</p>	 <p>TE Part # CAT-Q17-N490333 QSFP56-Four SFP56 Cable Assembly: 26 AWG</p>




TE Part # 4-2821222-5
SFP56 DIRECT ATTACH CA, 2M,
30AWG



TE Part # 4-2821224-5
SFP56 DIRECT ATTACH CA, 3M,
26AWG



TE Part # 4-2334985-2
SFP56 DIRECT ATTACH CA, 1M,
32AWG



TE Part # CAT-C11-H5
SFP+ to SFP+ I/O Cable Assembly: 24
AWG



TE Part # CAT-C11-H506
SFP+ to SFP+ I/O Cable Assembly: 26
AWG



TE Part # CAT-C11-H5062
SFP+ to SFP+ I/O Cable Assembly: 28
AWG



TE Part # 2057500-1
Light Pipe, Ganged SFP+



TE Part # 2142970-1
CABLE ASSY, MICRO SFP+ TO STD
SFP+, 0.5M



TE Part # 2142970-2
CABLE ASSY, MICRO SFP+ TO STD
SFP+, 1M



TE Part # 2142970-3
CABLE ASSY, MICRO SFP+ TO STD
SFP+, 2M



TE Part # 2142970-4
CABLE ASSY, MICRO SFP+ TO STD
SFP+, 3M



TE Part # 2142970-5
CABLE ASSY, MICRO SFP+ TO STD
SFP+, 4M

Customers Also Bought



TE Part #2299940-2
ZQSFP+ STACKED REC ASSEMBLY
2X1,HS



TE Part #3-794636-4
04P MICRO MNL ASSY,VRT,SMT,LF



TE Part #2-1445053-3
MICRO MNL HDR ASSY S/ROW LF



TE Part #1-338088-3
8/8 INV.MOD.JACK




TE Part #1-2176308-8
RP 1E 0.1W 200K 0.1% 25PPM 5K RL



TE Part #5-2176307-4
RP 1E 0.1W 44K2 0.1% 25PPM 5K RL



TE Part #2132404-1
CFP Hardware Kit



TE Part #1888810-2
EMI/Dust Cover,XFP And QSFP



Documents

Product Drawings

[SFP+assy2x1 EMI Sprg No Lp Sn Enhanced](#)

English

CAD Files

[3D PDF](#)

3D

Customer View Model

[ENG_CVM_CVM_1-2007492-8_E.2d_dxf.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1-2007492-8_E.3d_igs.zip](#)

English

Customer View Model

[ENG_CVM_CVM_1-2007492-8_E.3d_stp.zip](#)

English

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Product Specifications

[Application Specification](#)

English

Instruction Sheets

[Instruction Sheet \(U.S.\)](#)

English

[Instruction Sheet \(U.S.\)](#)

English

Agency Approvals

[UL Report](#)

English